IPC ASSOCIATION CONNECT ELECTRONICS INDUST.	© Copyright 2005. IPC,	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under bot international and Pan-American copyright conventions.			der both This do level pa	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowelevel parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute					Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information			
upplier Infor	rmation														
Company name*				Company unique ID			Unique ID Authority					Response Date*			
nsemi											2023-06-08				
Contact Name			Title - Contact			Phone	Phone - Contact*				Email - Contact*				
Product-Env-Ste	ewards	Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com					
uthorized Repre	esentative*	Title - Representative			Phone	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com				
Reque	Requester Item Number Mfr Item		Number Mfr Item Name			Effe	ctive Date	e Version		Manufacturing Site		Weight*	UOM	Unit Type	
		drive		3PH PRE SENSOR driver with hall sen speed control)	PH PRE SENSOR OPEN; Three phase pre- river with hall sensor method (open loop beed control)		3-06-08		:	РНМ		72.67	mg	Each	
Ianufacturin	g Proccess Information	ı													
Terminal Plating / Grid Array Material Terminal Plating / Grid Array Material			erminal Base Alloy J-STD-020 MSL		STD-020 MSL Rating		Peak Process Body Temperature Max Time at P			re Max Time at Peak	ak Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed CU			CU Alloy 3				260 C 30			seconds 3					
omments															
ITENTION: M	ISL 3 Rated item requires Ba	ke and D	ry Pack (after	electrical test)											
or more informa	ation regarding material com	position j	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	4.3	mg	Supplier	Silicon (Si)	7440-21-3		4.2841	mg
			Supplier	Polyimide	Proprietary Data		0.0159	mg
Die Attach	1.05	mg	Supplier	Silver (Ag)	7440-22-4		0.7822	mg
			Supplier	Epoxy resins	129915-35-1		0.0892	mg
			Supplier	Polybutadiene polymer	Proprietary Data		0.021	mg
			Supplier	Acrylic resins	Proprietary Data		0.1575	mg
Lead Frame	38.42	mg	Supplier	Silver (Ag)	7440-22-4		0.1883	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0576	mg
			Supplier	Iron (Fe)	7439-89-6		0.8798	mg
			Supplier	Copper (Cu)	7440-50-8		37.2828	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0115	mg
Mold Compound-Black	27.99	mg		Phenolic Resin	proprietary data		1.1196	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		1.8193	mg
			Supplier	Carbon Black (C)	1333-86-4		0.084	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		24.9671	mg
Plating	0.64	mg	Supplier	Tin (Sn)	7440-31-5		0.64	mg
Wire Bond - Au	0.27	mg	Supplier	Gold (Au)	7440-57-5		0.27	mg